深圳市金洛电子有限公司 SHENZHEN JINLUO ELECTRONICS CS CO.,LTD

产品承认书

产品名称: 声表面谐振器 Product Name: SAW 产品型号: R(''M) Product Model: R(''M) 产品体积: SMD3030mm Product volume: SMD3030mm

承认后请回传一份 PLS SEND BACK ONE COPY TO US AFTER YOUR APPROVAL

承认结果 CONCLUSION	客户签名 SIGNATURE	客户承认章 STAMP	日期 DATE	备注 REMARK
合格 ACCEPT				
不合格 REJECT				

制表:	童娟	审核:	
-			(公章)

尊敬的客户:请您抽取一点时间,在7-10个工作日内将承认书回签,若未回签,已视默认.谢谢合作!!!

SAMPLE APPROVAL SHEET

1. Scope

This specification shall cover the characteristics of 1-port SAW resonator with R433.92 used for remote-control security.

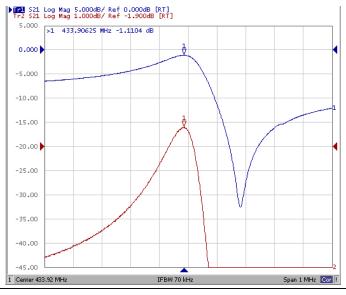
2. Electrical Specification

2.1 Maximum Rating

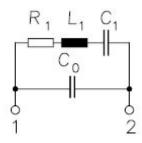
DC Voltage VDC	10V				
AC Voltage Vpp	10V 50Hz/60Hz				
Operation temperature	-40°C to +85°C				
Storage temperature	-45°C to +85°C				
Source Power	0dBm				

2.2 Electronic Characteristics

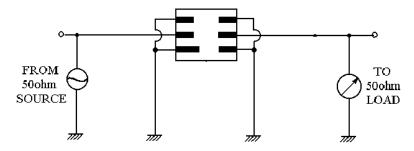
Item			Unites	Minimum	Typical	Maximum
Center Freque	ency		MHz	433.845	433.92	433.995
Insertion Loss	5		dB		1.4	1.9
Quality Factor Unload Q 50Ω Loaded Q			8000	12800		
		50Ω Loaded Q		1000	2000	
Temperature	Turnov	er Temperature	$^{\circ}$ C	10	25	40
Stability	mp.Coefficient	ppm/℃		0.032		
Frequency Ag		ppm/yr		<±10		
DC. Insulation Resistance			MΩ	1.0		
RF	Motion	al Resistance R1	Ω		17	26
Equivalent	Motion	al Inductance L1	μН		70.743	
RLC Model	al Capacitance C1	fF		1.9018		
Transducer Static Capacitance C0			pF		2.0	



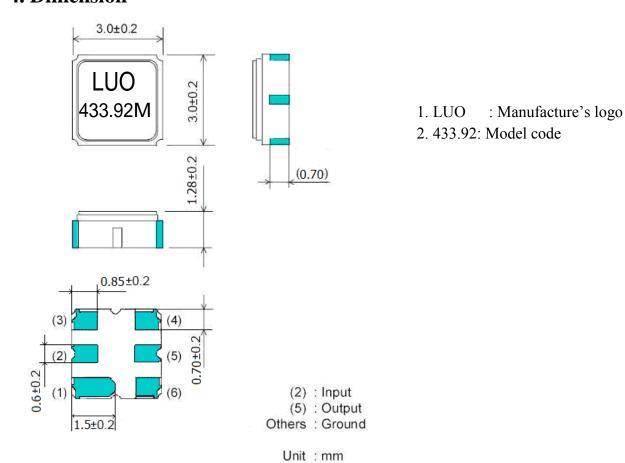
2.3 Equivalent LC Model



3. Test Circuit



4. Dimension



5. Environment Characteristic

5-1 Thermal Shock:

The components shall remain within the electrical specifications after being kept at the condition of heat cycle conditions: TA=-40 °C±3 °C, TB=85 °C±2 °C, t1=t2=30min, switch time \leq 3min& cycle time: 100 times, recovery time: 2h±0.5h.

5-2 Resistance to solder heat

Submerge the device terminals into the solder bath at $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 10 ± 1 sec. Then release the device into the room conditions for 4 hours. It shall meet the specifications in 2.2.

5-3 Solder ability

Submerge the device terminals into the solder bath at 245° C $\pm 5^{\circ}$ C for 5s, More than 95% area of the soldering pad must be covered with new solder. It shall meet the specifications in 2.2

5-4 The Temperature Storage:

- 5.3.1 High Temperature Storage: The components shall remain within the electrical specifications after being kept at the $85^{\circ}\text{C} \pm 2^{\circ}\text{C}$ for $96\text{h} \pm 4\text{h}$, recovery time : $2\text{h} \pm 0.5\text{h}$.
- 5.3.2 Low Temperature Storage: The components shall remain within the electrical specifications after being kept at the $-40^{\circ}\text{C} \pm 3^{\circ}\text{C}$ for 96h±4h, recovery time : 2h±0.5h.

5-5 Humidity test:

The components shall remain within the electrical specifications after being kept at the condition of ambient temperature $60^{\circ}\text{C}\pm2^{\circ}\text{C}$, and $90\sim96\%$ RH for $96\text{h}\pm4\text{h}$.

5-6 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m for 3 times. The resonator shall fulfill the specifications in 2.2.

5-7 Vibration

Subject the device to the vibration for 2 hour each in X, Y and Z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The resonator shall fulfill the specifications in 2.2.

6. Remark

6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

6.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.

7. Packing

7.1 Dimensions

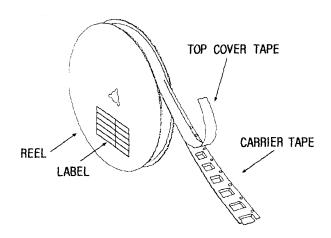
- (1) Carrier Tape: Figure 1
- (2) Reel: Figure 2
- (3) The product shall be packed properly not to be damaged during transportation and storage.

7.2 Reeling Quantity

1000 pcs/reel 7" 3000 pcs/reel 13"

7.3 Taping Structure

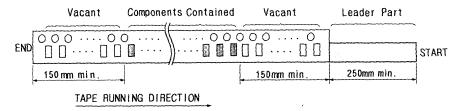
(1) The tape shall be wound around the reel in the direction shown below.



(2) Label

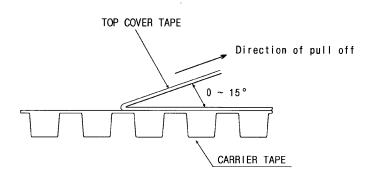
Device Name	
User Product Name	
Quantity	
Lot No.	

(3) Leader part and vacant position specifications.

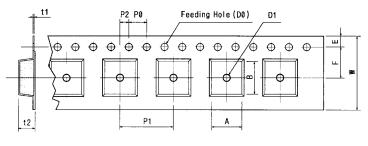


8. Tape Specifications

- 8.1 Tensile Strength of Carrier Tape: 4.4N/mm width
- 8.2 Top Cover Tape Adhesion (See the below figure)
 - (1) pull off angle: 0~15°
 (2) speed: 300mm/min.
 (3) force: 20~70g



[Figure 1] Carrier Tape Dimensions

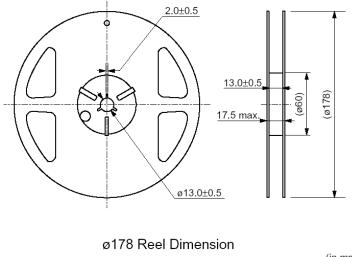


Tape Running Direction

[Unit: mm]

W	F	Е	P0	P1	P2	D0	D1	t1	t2	A	В
12.0	5.5	1.75	4.0	4.0	2.0	Ø1.5	Ø1.0	0.3	1.25	3.3±	3.3±
± 0.3	±0.05	±0.1	±0.1	±0.1	± 0.05	±0.1	±0.25	± 0.05	± 0.1	0.1	0.1

[Figure 2] Reel Dimensions



(in mm)

